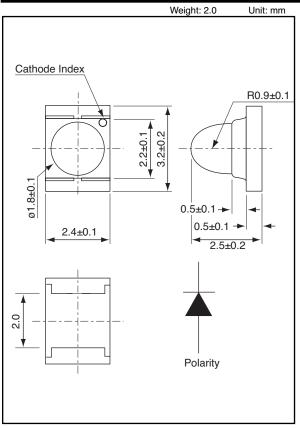


RoHS Compliant



Electro-Optical Characteristics ($T_a = 25^{\circ}C$)

Product specifications contained herein may be changed without prior notice. It is therefore advisable to contact Purdy Electronics before proceeding with the design of equipment incorporating this product.

AND5GA GaP Ultra Bright Green Light Emission Surface Mount Package

Features

- Small package size with dome lens
- 3.2 (l) x 2.4 (w) x 2.6 (h) size
- Suitable for REFLOW soldering

Recommended Forward Current: 10 mA

Maximum Ratings (T_a = 25°C)

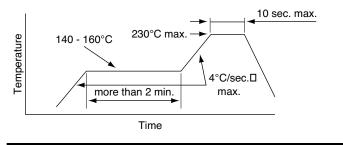
Characteristics	Symbol	Rating	Unit
Forward Current	١ _F	25	mA
Reverse Voltage	V _R	5	V
Power Dissipation	PD	60	mW
Operating Temperature Range	T _{Opr}	-40 to 85	°C
Storage Temperature Range	T _{Stg}	-40to 90	°C

Characteristics	Symbol	Test Condition	Minimum	Typical	Maximum	Unit		
Forward Voltage	V _F	I _F = 20 mA	-	2.1	2.4	V		
Reverse Current	I _R	V _R = 5 V	-	-	10	μA		
Luminous Intensity	Ι _V	I _F = 20 mA	75	125	-	mcd		
Peak Emission Wavelength	۱ _Р	I _F = 20 mA	-	570	-	nm		
Spectral Line Half Width	Δλ	I _F = 20 mA	-	30	-	nm		
Dominant Wavelength	λd	I _F = 20 mA	-	571	-	nm		
Full Viewing Angle	θ	I _V = 1/2 Peak	-	30	-	degree		

Precaution

Please be careful of the following:

- Manual soldering: maximum temperature of iron tip: 260°C max. Soldering time: within 5 sec. per solder-land Soldering portion of lead: up to 1.6 mm from the body of the device
- 2. Reflow solder: recommended condition is as follows:



The following soldering patterns are□ recommended for reflow soldering

